

200V, N-CHANNEL

REF: MIL-PRF-19500/555



REPETITIVE AVALANCHE AND dv/dt RATED HEXFET® TRANSISTORS THRU-HOLE TO-205AF (TO-39)

Product Summary

Part Number	BVDSS	RDS(on)	I _D
IRFF220	200V	Ω 08.0	3.5A



Description

The HEXFET® technology is the key to International Rectifier's HiRel advanced line of power MOSFET transistors. The efficient geometry and unique processing of this latest "State of the Art" design achieves: very low on state resistance combined with high trans conductance.

The HEXFET transistors also feature all of the well established advantages of MOSFETs such as voltage control, very fast switching and temperature stability of the electrical parameters.

They are well suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers and high energy pulse circuits.

Features

- Repetitive Avalanche Ratings
- Dynamic dv/dt Rating
- · Hermetically Sealed
- Simple Drive Requirements
- ESD Rating: Class 1B per MIL-STD-750, Method 1020

Absolute Maximum Ratings

Symbol	Parameter	Value	Units
I_{D1} @ V_{GS} = 10V, T_{C} = 25°C	Continuous Drain Current	3.5	
I _{D2} @ V _{GS} = 10V, T _C = 100°C	Continuous Drain Current	2.25	Α
I _{DM} @ T _C = 25°C	Pulsed Drain Current ①	14	
P _D @ T _C = 25°C	Maximum Power Dissipation	20	W
	Linear Derating Factor	0.16	W/°C
V_{GS}	Gate-to-Source Voltage	± 20	V
E _{AS}	Single Pulse Avalanche Energy ②	0.242	mJ
I _{AR}	Avalanche Current ①	2.2	Α
E _{AR}	Repetitive Avalanche Energy ①	2.0	mJ
dv/dt	Peak Diode Recovery dv/dt ③	5.0	V/ns
T _J	Operating Junction and	-55 to + 150	
T _{STG}	Storage Temperature Range	-55 10 + 150	°C
	Lead Temperature	300 (0.063 in. /1.6 mm from case for 10s)	
	Weight	0.98 (Typical)	g

For Footnotes, refer to the page 2.



Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BV _{DSS}	Drain-to-Source Breakdown Voltage	200			V	$V_{GS} = 0V, I_{D} = 1.0mA$
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.25		V/°C	Reference to 25°C, I _D = 1.0mA
R _{DS(on)}	Static Drain-to-Source On-Resistance			0.80	Ω	V _{GS} = 10V, I _{D2} = 2.25A ④
				0.85		V _{GS} = 10V, I _{D1} = 3.5A ④
$V_{GS(th)}$	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Gfs	Forward Transconductance	1.5			S	V _{DS} = 15V, I _{D2} = 2.25A ④
I_{DSS}	Zero Gate Voltage Drain Current			25		$V_{DS} = 160 \text{ V}, V_{GS} = 0 \text{V}$
	Zelo Gate Voltage Dialii Cullent			250	μΑ	$V_{DS} = 160V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
I_{GSS}	Gate-to-Source Leakage Forward			100	nA	$V_{GS} = 20V$
	Gate-to-Source Leakage Reverse			-100	IIA	V _{GS} = -20V
Q_G	Total Gate Charge	8.0		14.3		I _{D1} = 3.5A
Q_GS	Gate-to-Source Charge	0.9		3.0	nC	V _{DS} = 100V
Q_{GD}	Gate-to-Drain ('Miller') Charge	2.3		9.0		V _{GS} = 10V
t _{d(on)}	Turn-On Delay Time			40		$V_{DD} = 74V$
tr	Rise Time			50		$I_{D1} = 3.5A$
$t_{d(off)}$	Turn-Off Delay Time			50	ns	$R_G = 7.5\Omega$
t _f	Fall Time			50		V _{GS} = 10V
Ls +L _D	Total Inductance		7.0			Measured from Drain lead (6mm / 0.25 in from package) to Source lead (6mm/ 0.25 in from package) with Source wire internally bonded from Source pin to Drain pin
C _{iss}	Input Capacitance		260			$V_{GS} = 0V$
Coss	Output Capacitance		100		pF	V _{DS} = 25V
C_{rss}	Reverse Transfer Capacitance		30			f = 1.0MHz

Source-Drain Diode Ratings and Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Is	Continuous Source Current (Body Diode)			3.5	^	
I _{SM}	Pulsed Source Current (Body Diode) ①			14	A	
V_{SD}	Diode Forward Voltage			1.5	V	$T_J = 25^{\circ}C, I_S = 3.5A, V_{GS} = 0V$
t _{rr}	Reverse Recovery Time			400	ns	$T_J = 25^{\circ}C, I_F = 3.5A, V_{DD} \le 50V$
Q _{rr}	Reverse Recovery Charge			4.3	μC	di/dt = 100A/μs ④
t _{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S + L_D$)				

Thermal Resistance

Symbol	Parameter	Min.	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case			6.25	°C/\/\
$R_{\theta JA}$	Junction-to-Ambient (Typical Socket Mount)			175	°C/W

Footnotes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- $^{\circ}$ V_{DD} = 50V, starting T_J = 25°C, L = 100 μ H, Peak I_L = 2.2A
- $\label{eq:local_spin_spin} \ \, I_{SD} \leq 3.5 A, \, di/dt \leq 95 A/\mu s, \, V_{DD} \leq 200 V, \, T_J \leq 150^{\circ} C, \, Suggested \,\, R_G = 7.5 \,\, \Omega$

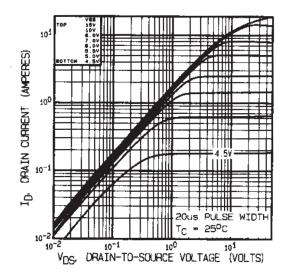


Fig 1. Typical Output Characteristics

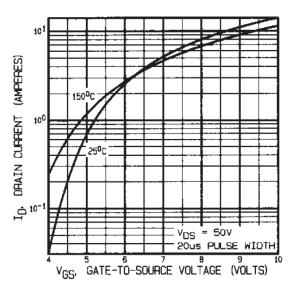


Fig 3. Typical Transfer Characteristics

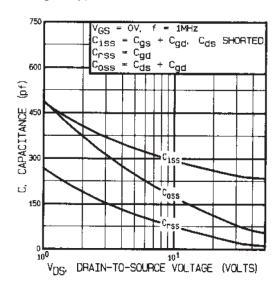


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

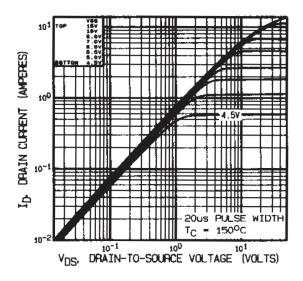


Fig 2. Typical Output Characteristics

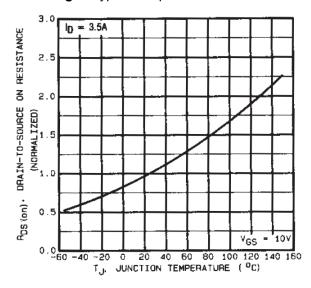


Fig 4. Normalized On-Resistance Vs. Temperature

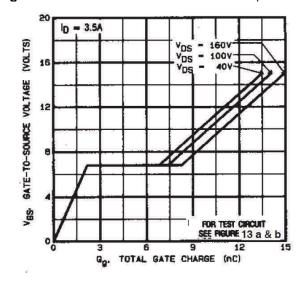


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

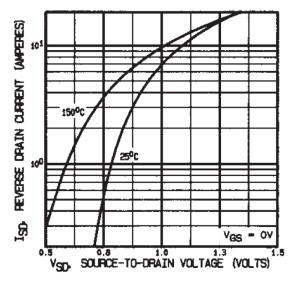


Fig 7. Typical Source-Drain Diode Forward Voltage

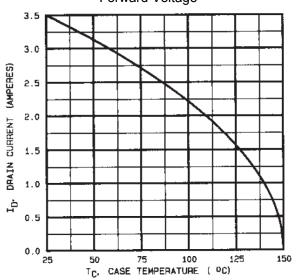


Fig 9. Maximum Drain Current Vs. Case Temperature

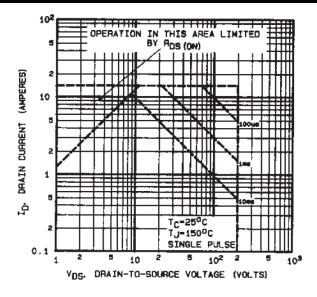


Fig 8. Maximum Safe Operating Area

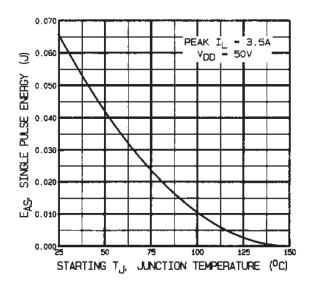


Fig 10. Maximum Avalanche Energy Vs. Drain Current

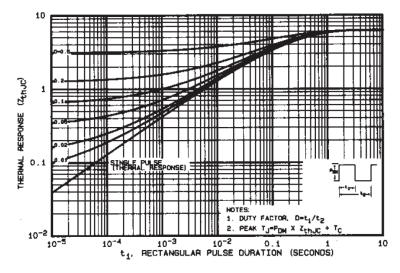


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

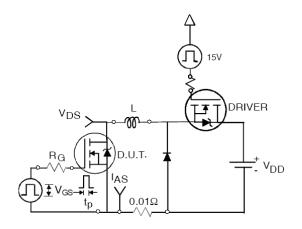


Fig 12a. Unclamped Inductive Test Circuit

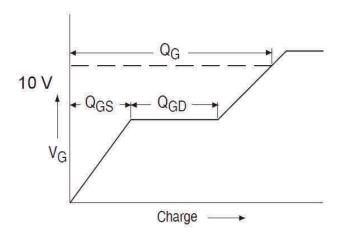


Fig 13a. Gate Charge Waveform

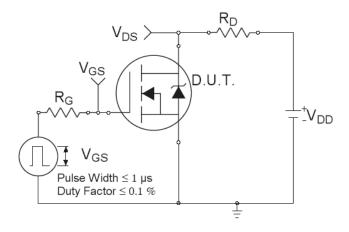


Fig 14a. Switching Time Test Circuit

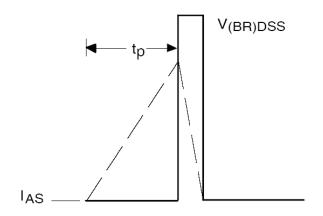


Fig 12b. Unclamped Inductive Waveforms

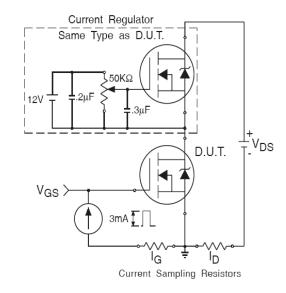


Fig 13b. Gate Charge Test Circuit

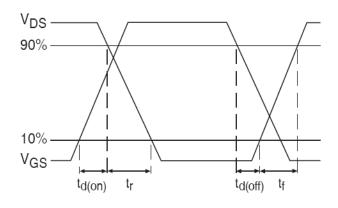
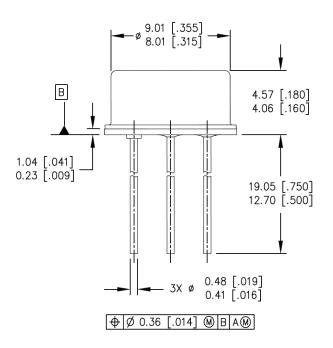


Fig 14b. Switching Time Waveforms



Case Outline and Dimensions - TO-205AF (TO-39)

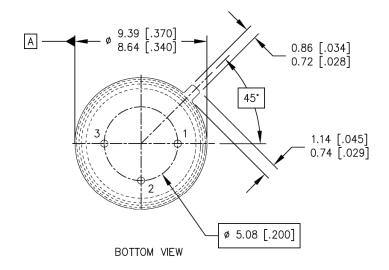


NOTES:

DIMENSIONING AND TOLERANCING PER ASME 14.5M-1994.

SIDE VIEW

- 2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- 3. CONTROLLING DIMENSION: INCH.
- 4. CONFORMS TO JEDEC OUTLINE TO-205AF (TO-39).



LEGEND

- 1- SOURCE
- 2- GATE
- 3- DRAIN (CONNECTED TO THE CASE)



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